General Description

The MAX77816 is a high-current, high-efficiency buck-boost regulator targeting single-cell Li-ion batterypowered applications. It supports a wide output voltage range from 2.60V to 5.14V. The IC allows 5A (typ) maximum switch current. In buck mode, the output current can go as high as 4A, and in boost mode, the maximum output current can be 3A. A unique control algorithm allows high efficiency, outstanding line/load transient response, and seamless transition between buck and boost modes.

The IC features an I²C-compatible serial interface. The I²C interface allows the output voltage to be dynamically adjusted, thus enabling finer control of system power consumption. The I²C interface also provides features such as enable control and device status monitoring.

The multifunction GPIO pin is register settable to 5 different options, such as FPWM mode enable and inductor peak current level selection. These options provide design flexibility that allows the IC to cover a wide range of applications and use cases.

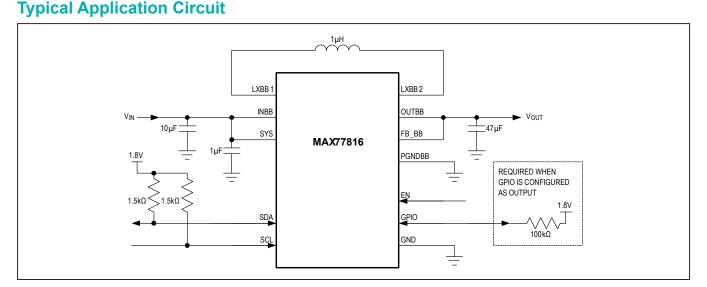
Applications

- Smartphones and Tablets
- Wearable Devices
- Wireless Communication Devices
- RF Power Amplifiers
- Battery-Powered Applications

High-Efficiency Buck-Boost Regulator with 5A Switches

Benefits and Features

- Buck and Boost Operation Including Seamless Transition between Buck and Boost Modes
 - 2.3V to 5.5V V_{IN} Range
 - + 2.60V to 5.14V $V_{\mbox{OUT}}$ with 20mV Step
 - 3A Minimum Continuous Output Current (V_{INBB} ≥ 3.0V, V_{OUTBB} = 3.3V)
 - Burst Current: 3.6A Minimum Output Current for 800µs (V_{INBB} ≥ 3.0V, V_{OUTBB} = 3.3V)
- I²C Serial Interface Allows Dynamic V_{OUT} Adjustment and Provides Design Flexibility
- 97.5% Peak Efficiency
- 40µA Quiescent Current
- Safety Features Enhance Device and System Reliability
 - Soft-Start
 - True Shutdown[™]
 - Thermal Shutdown and Short-Circuit Protection
- Multifunction GPIO Pin
- MAX77816A/F: FPWM Mode Enable
- MAX77816B: Inductor Peak Current-Limit selection
- MAX77816C: Output Voltage Selection
- MAX77816D: Power-OK indicator
- MAX77816E: Interrupt Indicator
- Small Size: 1.827mm x 2.127mm, 20-Bump WLP, 0.4mm Pitch



Ordering Information appears at end of data sheet.

True Shutdown is a trademark of Maxim Integrated Products, Inc.



High-Efficiency Buck-Boost Regulator with 5A Switches

Absolute Maximum Ratings

SYS to GND	0.3V to +6.0V
INBB, OUTBB to PGNDBB	-0.3V to +6.0V
PGNDBB to GND	-0.3V to +0.3V
SCL, SDA to GND	0.3V to (V _{SYS} + 0.3V)
EN, GPIO to GND	0.3V to (V _{SYS} + 0.3V)
FB_BB to GND	0.3V to (V _{OUTBB} + 0.3V)
LXBB1 to PGNDBB	0.3V to (V _{INBB} + 0.3V)
LXBB2 to PGNDBB	0.3V to (V _{OUTBB} + 0.3V)

LXBB to PGND (Pulsed < 5ns Voltage)2.4V to 8.0V
LXBB1/LXBB2 Continuous RMS Current (Note 1)4.8A
Operating Temperature Range40°C to +85°C
Junction Temperature+150°C
Storage Temperature Range65°C to +150°C
Soldering Temperature (reflow)+260°C
Continuous Power Dissipation at $T_A = +70^{\circ}C$
(Derate 23.8mW/°C above +70°C)1905mW

Note 1: LXBB1/LXBB2 node has internal clamp diodes to PGNDBB and INBB. Applications that give forward bias to these diodes should ensure that the total power loss does not exceed the power dissipation limit of IC package.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Package Thermal Characteristics (Note 2)

Junction-to-Ambient Thermal Resistance (0,JA).......55.49°C/W

Note 2: Package thermal resistances were obtained using the method described in JEDEC specification JESD51-7, using a four-layer board. For detailed information on package thermal considerations, refer to **www.maximintegrated.com/thermal-tutorial**.

Electrical Characteristics

 $(V_{SYS} = V_{INBB} = +3.8V, V_{FB_BB} = V_{OUTBB} = +3.3V, T_A = -40^{\circ}C$ to +85°C, typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
GENERAL						
Input Voltage Range	V _{INBB}		2.3		5.5	V
Chutdown Cumply Current	I _{SHDN_25C}	$EN = low, T_A = +25^{\circ}C$			1	
Shutdown Supply Current	I _{SHDN_85C}	EN = low, T_A = +85°C (Note 5)		1		μA
Input Supply Current	I _{Q_SKIP}	SKIP mode, no switching		40	60	μA
Input Supply Current	I _{Q_PWM}	FPWM mode, no load		6		mA
Active Discharge Resistance	R _{DISCHG}			100		Ω
Thermal Shutdown	T _{SHDN}	Rising, 20°C hysteresis		+165		°C
H-BRIDGE	•					
Output Voltage Range	V _{OUT}	I ² C programmable (20mV step)	2.60		5.14	V
Default Quitaut Valtage		MAX77816A only, VOUT [6:0] = 0x28		3.4		V
Default Output Voltage		MAX77816B/C/D/E/F, VOUT [6:0] = 0x23		3.3		
	VOUT_ACC1	PWM mode, no load	-1.0		+1.0	
Output Voltage Accuracy	V _{OUT_ACC2}	SKIP mode, no load, T _A = +25°C	-1.0		+4.5	%
Line Regulation		V _{INBB} = 2.3V to 5.5V		0.200		%/V
Load Regulation		(Note 4)		0.125		%/A
Line Transient Response	e Transient Response $ \begin{array}{c} V_{OS1} \\ V_{US1} \end{array} \begin{array}{c} I_{OUT} = 1.5A, V_{INB} \text{changes from } 3.4V \\ \text{to } 2.9V \text{in } 25\mu\text{s} (20\text{mV}/\mu\text{s}), \text{L} = 1\mu\text{H}, \\ C_{OUT_NOM} = 47\mu\text{F} (\text{Note } 4) \end{array} $			50		mV

High-Efficiency Buck-Boost Regulator with 5A Switches

Electrical Characteristics (continued)

 $(V_{SYS} = V_{INBB} = +3.8V, V_{FB}BB = V_{OUTBB} = +3.3V, T_A = -40^{\circ}C$ to +85°C, typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Load Transient Response	V _{OS2} V _{US2}	I_{OUT} changes from 10mA to 1.5A in 15µs, L = 1µH, C _{OUT_NOM} = 47µF (Note 4)		50		mV
Output Voltage Ramp-Up		BB_RU_SR = 0 (Note 6)		20		m)//uo
Slew Rate		BB_RU_SR = 1 (Note 6)		40		mV/µs
Output Voltage Ramp-down		BB_RD_SR = 0 (Note 6)		5		mV/µs
Slew Rate		BB_RD_SR = 1 (Note 6)		10		πν/μ3
Typical Load Efficiency	ηιουτ_τγρ	I _{OUT} = 100mA (Note 4)		95		%
Peak Efficiency	ηρκ	(Note 4)		97.5		%
		ILIM[1:0] = 11b or GPIO_CFG[2:0] = 010b, GPIO = high	4	5	5.8	
LXBB1/2 Current Limit		ILIM[1:0] = 10b		3.1		A
LABB 1/2 Current Limit	I _{LIM_LXBB}	ILIM[1:0] = 01b or GPIO_CFG[2:0] = 010b, GPIO = low		1.80		
		ILIM[1:0] = 00b	1.15			
High-Side PMOS ON Resistance	R _{DSON} (PMOS)	I _{LXBB} = 100mA per switch		34		mΩ
Low-Side NMOS ON Resistance	R _{DSON(NMOS)}	I _{LXBB} = 100mA per switch		45		mΩ
Switching Frequency	f _{SW}	PWM mode, T _A = +25°C	2.25	2.50	2.75	MHz
Turn-On Delay Time	ton_dly	From EN asserting to LXBB switching (Note 6)		100		μs
Coff Chart Time		I _{OUT} = 10mA, ILIM[1:0] = 11b or 10, or GPIO_CFG[2:0] = 010b, GPIO = high (Note 4)		120		
Soft-Start Time	t _{SS}	IOUT = 10mA, ILIM[1:0] = 01b or 00, or GPIO_CFG[2:0] = 010b, GPIO = low (Note 4)		800		- µs
Minimum Effective Output Capacitance	C _{EFF(MIN)}	0A < I _{OUT} < 3000mA		16		μF
LXBB1, LXBB2 Leakage Current	I _{LK_25}	$V_{LXBB1/2} = 0V \text{ or } 5.5V, V_{OUTBB} = 5.5V, V_{SYS} = V_{INBB} = 5.5V, T_A = +25^{\circ}C$		0.1	1	
	I _{LK_85}	$V_{LXBB1/2} = 0V \text{ or } 5.5V, V_{OUTBB} = 5.5V, V_{SYS} = V_{INBB} = 5.5V, T_A = +85^{\circ}C$ (Note 5)		0.2		μA
SYS Undervoltage Lockout	V _{UVLO_R}	V _{SYS} rising	2.375	2.50	2.625	v
Threshold	V _{UVLO F}	V _{SYS} falling		2.05		

High-Efficiency Buck-Boost Regulator with 5A Switches

Electrical Characteristics (continued)

 $(V_{SYS} = V_{INBB} = +3.8V, V_{FB}BB = V_{OUTBB} = +3.3V, T_A = -40^{\circ}C$ to +85°C, typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS	
ENABLE INPUT (EN)							
EN Logic-Low Threshold	V _{EN_L}	$V_{SYS} \le 5.5V, T_A = +25^{\circ}C$			0.4	V	
EN Logic-High Threshold	V _{EN_H}	$V_{SYS} \le 5.5V, T_A = +25^{\circ}C$	1.2			V	
EN Internal Pulldown Resistance	R _{EN}	Pulldown resistor to GND	400	800	1600	kΩ	
GENERAL PURPOSE INPUT/O	OUTPUT (GPIO)						
Input Logic-Low Threshold	V _{GPI_L}	GPIO[2:0] = 001b or 010b or 011b, V _{SYS} \leq 4.5V, T _A = +25°C			0.4	V	
Input Logic-High Threshold	V _{GPI_H}	GPIO[2:0] = 001b or 010b or 011b, V _{SYS} ≤ 4.5V, T _A = +25°C	1.2			V	
Input Internal Pulldown Resistance	R _{EN}	GPIO[2:0] = 001b or 010b or 011b, Pulldown resistor to GND	400	800	1600	V	
Output Low Voltage	V _{GPO_L}	GPIO[2:0] = 100b or 101b, I _{SINK} = 1mA			0.4	V	
	I _{GPO_25C}	GPIO[2:0]=100b or 101b, T _A = +25°C	-1		+1	μΑ	
Output Leakage Current	I _{GPO_85C}	GPIO[2:0] = 100b or 101b, T _A = +85°C (Note 5)		0.1			
DOK Threehould	VPOK_R	GPIO[2:0] = 100b, V _{OUTBB} rising, expressed as a percentage of V _{OUTBB}		92.5		0/	
POK Threshould	VPOK_F	GPIO[2:0] = 100b, V _{OUTBB} falling, expressed as a percentage of V _{OUTBB}		90		%	
I ² C-COMPATIBLE INTERFACE	E—I/O STAGE	-					
SCL, SDA Input High Voltage	V_{IH}		1.4			V	
SCL, SDA Input Low Voltage	V _{IL}				0.4	V	
SCL, SDA Input Hysteresis	V _{HYS}	(Note 5)		0.1		V	
SCL, SDA Input Current	lı		-10		+10	μA	
SDA Output Low Voltage	V _{OL}	I _{SINK} = 3mA			0.4	V	
SCL, SDA Input Capacitance	Cl				10	pF	
Maximum Pulse Width of Spikes that must be suppressed by the input filter	t _{SP}	(Note 5)		50		ns	

High-Efficiency Buck-Boost Regulator with 5A Switches

Electrical Characteristics (continued)

 $(V_{SYS} = V_{INBB} = +3.8V, V_{FB_BB} = V_{OUTBB} = +3.3V, T_A = -40^{\circ}C$ to +85°C, typical values are at $T_A = +25^{\circ}C$, unless otherwise noted.) (Note 3)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS		
I ² C-COMPATIBLE INTERFACE—TIMING (Note 5)								
Clock Frequency	f _{SCL}				1	MHz		
Hold Time (REPEATED) START Condition	tHD_STA		0.26			μs		
SCL Low Period	t _{LOW}		0.5			μs		
SCL High Period	thigh		0.26			μs		
Setup Time REPEATED START Condition	^t su_sta		0.26			μs		
DATA Hold Time	^t HD_DAT		0			μs		
DATA Setup Time	^t SU_DAT		50			ns		
Setup Time for STOP Condition	tsu_sto		0.26			μs		
Bus-Free Time Between STOP and START	t _{BUF}		0.5			μs		
Capacitive Load for Each Bus Line	CB				550	pF		

Note 3: Limits are 100% production tested at $T_A = +25^{\circ}$ C. Limits over the operating temperature range are guaranteed through correlation using statistical quality control methods.

Note 4: Guaranteed by design. Not production tested.

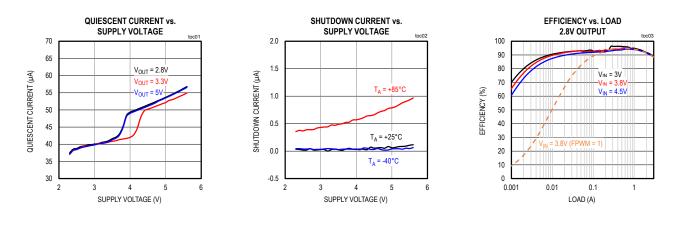
Note 5: Guaranteed by ATE characterization. Not directly tested in production.

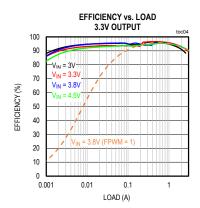
Note 6: Guaranteed by design. Production tested through scan.

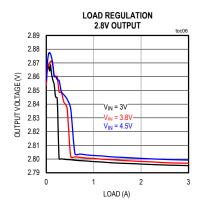
High-Efficiency Buck-Boost Regulator with 5A Switches

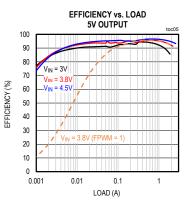
Typical Operating Characteristics

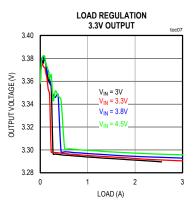
 $(V_{SYS} = V_{INBB} = +3.8V, V_{FB}_{BB} = V_{OUTBB} = +3.3V, T_A = +25^{\circ}C.)$







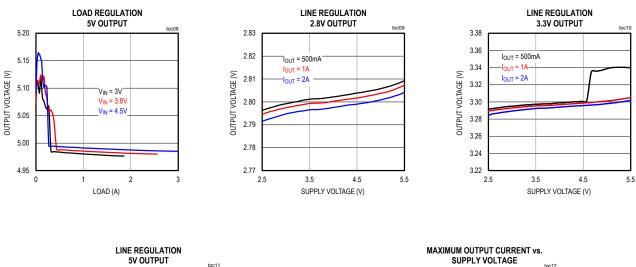


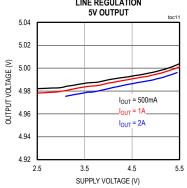


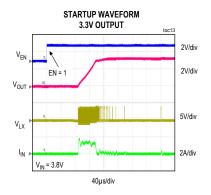
High-Efficiency Buck-Boost Regulator with 5A Switches

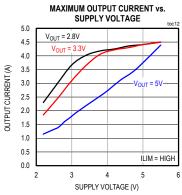
Typical Operating Characteristics (continued)

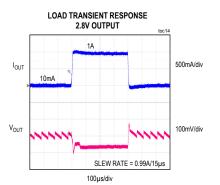
 $(\mathsf{V}_{\mathsf{SYS}}$ = $\mathsf{V}_{\mathsf{INBB}}$ = +3.8V , $\mathsf{V}_{\mathsf{FB}_\mathsf{BB}}$ = $\mathsf{V}_{\mathsf{OUTBB}}$ = +3.3V, T_{A} = +25°C.)







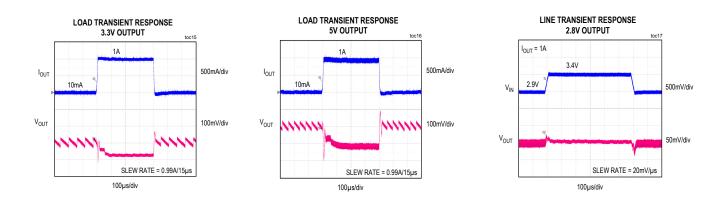


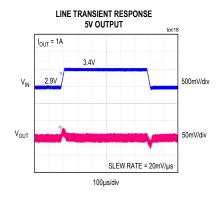


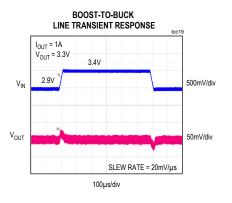
High-Efficiency Buck-Boost Regulator with 5A Switches

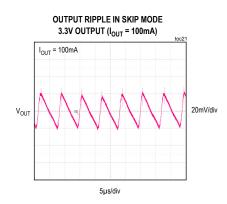
Typical Operating Characteristics (continued)

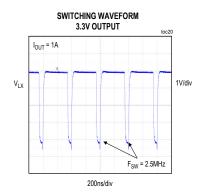
(V_{SYS} = V_{INBB} = +3.8V , V_{FB_BB} = V_{OUTBB} = +3.3V, T_A = +25^{\circ}C.)





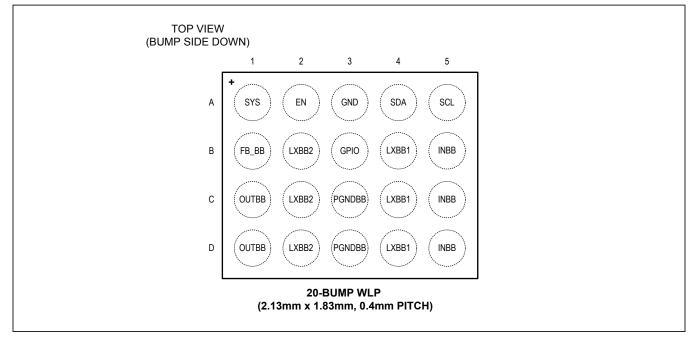






High-Efficiency Buck-Boost Regulator with 5A Switches

Bump Configuration



Bump Description

BUMP	NAME	FUNCTION
A1	SYS	System (Battery) Voltage Input. Bypass to GND with a 1µF capacitor.
A2	EN	Active-High, Buck-Boost External Enable Input. An $800k\Omega$ internal pulldown resistance to the GND.
A3	GND	Quite Ground. Star-ground connection to system GND.
A4	SDA	I ² C Data I/O (Hi-Z in OFF State). This pin requires a pullup resistor to I ² C power supply. Connect to GND if not used.
A5	SCL	I ² C Clock Input (Hi-Z in OFF State). This pin requires a pullup resistor to I ² C power supply. Connect to GND if not used.
B1	FB_BB	Buck-Boost Output Voltage Feedback
B2, C2, D2	LXBB2	Buck-Boost Switching Node 2
В3	GPIO	Multifunction GPIO: MAX77816A/B/C/F: General Purpose Input. An 800kΩ internal pulldown resistance to the GND. MAX77816D/E: Open-Drain Output. An external pullup resistor is required.
B4, C4, D4	LXBB1	Buck-Boost Switching Node 1
B5, C5, D5	INBB	Buck-Boost Input. Bypass to PGNDBB with a 10µF capacitor.
C1, D1	OUTBB	Buck-Boost Output
C3, D3	PGNDBB	Buck-Boost Power Ground. Star-ground connection to system GND.

High-Efficiency Buck-Boost Regulator with 5A Switches

Detailed Description

Enable Control

When EN pin is set to high, the IC turns on the internal bias circuitry, which takes typically 100 μ s (t_{ON_DLY}) to be settled. As soon as the bias is ready, all user registers are accessible through I²C. Write BB_EN bit to 1 to enable (register default) buck-boost output voltage regulation. The V_{OUTBB} takes 800 μ s (t_{SS}) to the nominal regulated voltage after BB_EN's setting.

When EN pin is pulled low, the IC goes into shutdown mode. This event also resets all type-O registers to their POR default values.

Immediate Turn-Off Events

The following events initiate immediate turn-off.

- Thermal protection $(T_J > +165^{\circ}C)$
- V_{SYS} < SYS UVLO falling threshold (V_{UVLO F})
- Overcurrent protection (I_{LIM} is consistently hit for 3ms)

The events in this category disable buck-boost until the hazardous conditions come back to normal conditions.

Inductor Peak Current Limit (ILIM)

The buck-boost regulator's high-side MOSFETs peak current limit (I_{LIM}_{LXBB}) is register programmable. Applications can use I_{LIM}_{LXBB} programmability to ensure that the regulator never exceeds the saturation current rating of the inductor on the PCB. In MAX77816B, I_{LIM}_{LXBB} is GPIO pin programmable. See the <u>Multifunction</u> <u>GPIO Pin</u> section.

Multifunction GPIO Pin

The IC has a general-purpose input and output (GPIO) pin which can be configured as 5 different functions through GPIO_CFG[2:0]. The default function of the GPIO pin is listed below:

 MAX77816A/MAX77816F: FPWM Mode Enable When the GPIO pin is connected to GND, the buckboost regulator automatically transitions from SKIP mode to fixed-frequency operation (PWM) as load current increases. SKIP mode helps maximize the

Table 1. Enable Control Logic Truth Table

EN PIN	BB_EN BIT	OPERATING MODE
low	x	Device off
high	0	Disable output
high	1 (default)	Enable output

buck-boost regulator's efficiency at light load. When the GPIO is connected to a voltage above V_{GPI_H} , forced PWM (FPWM) switching behavior is enabled. The FPWM mode benefits applications where lowest output ripple is required. The BB_FPWM bitfield is ignored when GPIO_CFG[2:0] = 001b.

The MAX77816A has a 3.4V default output voltage, and the MAX77816F has a 3.3V default output voltage.

MAX77816B: Inductor Peak Current-Limit (ILIM) Selection

The buck-boost regulator's high-side MOSFETs peak current limit (I_{LIM}_{LXBB}) is GPIO pin programmable. The ILIM[1:0] bitfield is ignored when GPIO_CFG[2:0] = 010b. Connect GPIO to GND to set ILIM to 1.8A (typ). Connect GPIO to a voltage above V_{GPI_H} to program ILIM to 5A (typ).

MAX77816C: Output Voltage Selection

The GPIO pin sets the output voltage dynamically between VOUT[6:0] (GPIO = LOW) and VOUT_H[6:0] (GPIO = HIGH). When EN pin is asserted, the status of the GPIO pin is latched until completing soft-start so that changes on the GPIO pin are ignored. After soft-start is done, internal logic sets V_{OUTBB} based on the GPIO input.

- MAX77816D: Power-OK (POK) Indicator The device features an open-drain GPIO output to monitor the output voltage. The GPIO pin requires an external pullup resistor. GPIO goes high (high impedance) after the output increases above 92.5% (V_{POK_R}) of the nominal regulated voltage (V_{OUT_REG}). GPIO goes low when the regulator output drops below 90% (V_{POK_F}) of V_{OUT_REG}.
- MAX77816E: Interrupts Indicator The GPIO indicates the application processor that the status of the device has changed.

INT[3:0], INT_MASK[3:0], and the GPIO pin work together to present the buck-boost regulator's abnormal status, including overvoltage, overcurrent, power OK, and thermal shutdown. GPIO goes low when one or more bits of INT[3:0] becomes 1, and the related interrupts are not masked in INT_MASK[3:0]. GPIO becomes high (cleared) as soon as the read action of INT[3:0] starts.

High-Efficiency Buck-Boost Regulator with 5A Switches

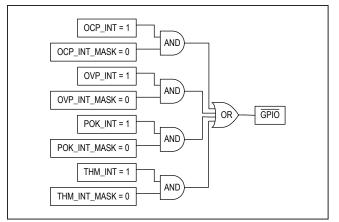


Figure 1. Interrupt Network

Buck-Boost Regulator

The MAX77816 buck-boost regulator utilizes a four-switch H-bridge configuration to realize buck, buck-boost, and boost operating modes. In this way, this topology maintains output voltage regulation when the input voltage is greater than, equal to, or less than the output voltage. The MAX77816 buck-boost is ideal in Li-ion batterypowered applications providing 2.60V to 5.14V of output voltage range and up to 3A of output current. High switching frequency and a unique control algorithm allow the smallest solution size, low output noise, and highest efficiency across a wide input voltage and output current range.

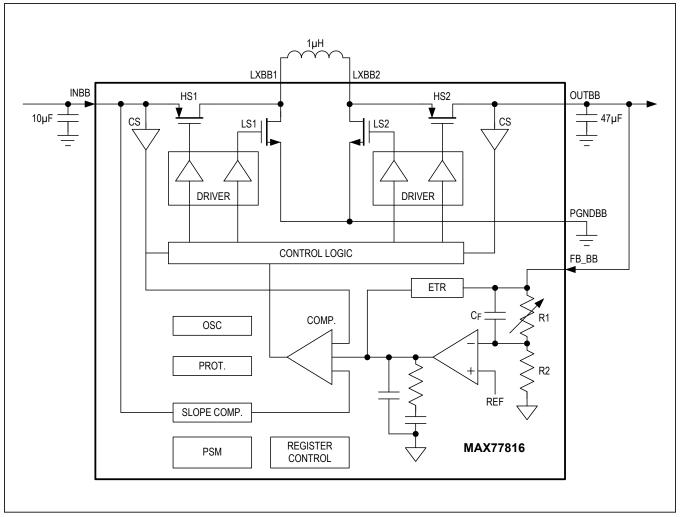


Figure 2. Buck-Boost Block Diagram

High-Efficiency Buck-Boost Regulator with 5A Switches

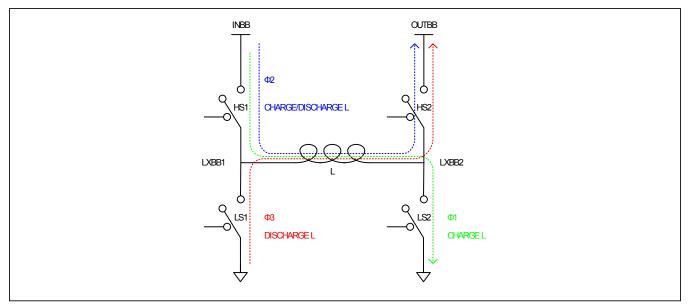


Figure 3. Buck-Boost Switching Intervals

H-Bridge Controller

H-bridge architecture operates at a 2.5MHz fixed frequency with a pulse-width-modulated (PWM), current-mode control scheme. This topology is in a cascade of a boost regulator and a buck regulator using a single inductor and output capacitor. Buck, buck-boost, and boost stages are 100% synchronous for highest efficiency in portable applications.

There are three phases implemented with the H-bridge switch topology, as shown in Figure 3:

- Φ1 Switch period (Phase-1: HS1 = ON, LS2 = ON) stores energy in the inductor, ramping up the inductor current at a rate proportional to the input voltage divided by inductance; V_{INBB}/L.
- Φ2 Switch period (Phase-2: HS1 = ON, HS2 = ON) ramps the inductor current up or down, depending on the differential voltage across the inductor, divided by inductance; ±(V_{INBB} – V_{OUTBB})/L.
- Φ3 Switch period (Phase-3: LS1 = ON, HS2 = ON) ramps down the inductor current at a rate proportional to the output voltage divided by inductance; -V_{OUTBB} /L.

2-Phase buck topology is utilized when V_{INBB} > V_{OUTBB}. A switching cycle is completed in one clock period. Switch period $\Phi 2$ is followed by switch period $\Phi 3$, resulting in an inductor current waveform similar to Figure 4.

2-Phase boost topology is utilized when V_{INBB} < V_{OUTBB}. A switching cycle is completed in one clock period. Switch period Φ 1 is followed by switch period Φ 2, resulting in an inductor current waveform similar to Figure 5.

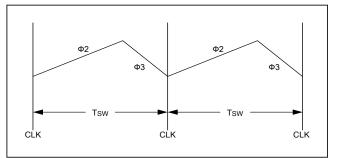


Figure 4. 2-Phase Buck Mode Switching Current Waveforms

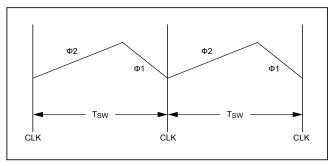


Figure 5. 2-Phase Boost Mode Switching Current Waveforms

Output Voltage Slew-Rate Control

The buck-boost regulator supports programmable slewrate control feature when increasing and decreasing the output voltage. The ramp-up slew-rate can be set to $20mV/\mu s$ or $40mV/\mu s$ through the BB_RU_SR bit, while the ramp-down slew-rate is programmable to $5mV/\mu s$ or $10mV/\mu s$ through the BB_RD_SR bit.

Output Active Discharge

Buck-boost provides an internal 100Ω resistor for output active discharge function. If the active discharge function is enabled (BB_AD = 1), the internal resistor discharges the energy stored in the output capacitor to PGNDBB whenever the regulator is disabled.

Either the regulator remains enabled or the active discharge function is disabled (BB_AD = 0), the internal resistor is disconnected from the output. If the active discharge function is disabled, the output voltage decays at a rate that is determined by the output capacitance and the load current when the regulator is turned off.

Inductor Selection

Buck-boost is optimized for a 1μ H inductor. The lower the inductor DCR, the higher buck-boost efficiency is. Users need to trade off inductor size with DCR value and choose a suitable inductor for buck-boost.

Input Capacitor Selection

The input capacitor, C_{IN} , reduces the current peaks drawn from the battery or input power source and reduces switching noise in the device. The impedance of C_{IN} at the switching frequency should be kept very low. Ceramic capacitors with X5R or X7R dielectrics are highly recommended due to their small size, low ESR, and small temperature coefficients. For most applications, a $10\mu F$ capacitor is sufficient.

Output Capacitor Selection

The output capacitor, C_{OUT} , is required to keep the output voltage ripple small and to ensure regulation loop

High-Efficiency Buck-Boost Regulator with 5A Switches

stability. C_{OUT} must have low impedance at the switching frequency. Ceramic capacitors with X5R or X7R dielectric are highly recommended due to their small size, low ESR, and small temperature coefficients. For stable operation, buck-boost requires 16µF of minimum effective output capacitance. Considering the DC bias characteristic of ceramic capacitors, a 47µF 6.3V capacitor is recommended for most of applications.

PCB Layout Guidelines

Careful circuit board layout is critical to achieve low switching power losses and clean, stable operation. Figure 6 shows an example HDI PCB layout for the MAX77816 WLP package.

When designing the PCB, follow these guidelines:

- Place the input capacitors C_{IN} and output capacitors C_{OUT} immediately next to the IN pin and OUT pin, respectively, of the IC. Since the IC operates at a high switching frequency, this placement is critical for minimizing parasitic inductance within the input and output current loops, which can cause high-voltage spikes and may damage the internal switching MOSFETs.
- 2) Place the inductor next to the LX bumps (as close as possible) and make the traces between the LX bumps and the inductor short and wide to minimize PCB trace impedance. Excessive PCB impedance reduces converter efficiency. When routing LX traces on a separate layer (as in the examples), make sure to include enough vias to minimize trace impedance. Routing LX traces on multiple layers is recommended to further reduce trace impedance. Furthermore, do not make LX traces take up an excessive amount of area. The voltage on this node switches very quickly and additional area creates more radiated emissions.
- Prioritize the low-impedance ground plane of the PCB directly underneath the IC, C_{OUT}, C_{IN}, and inductor. Cutting this ground plane risks interrupting the switching current loops.

MANUFACTURER	SERIES	NOMINAL INDUCTANCE (µH)	DC RESISTANCE (typ) (mΩ)	CURRENT RATING (A) -30% (∆L/L)	CURRENT RATING (A) ∆T = -40°C RISE	DIMENSIONS L x W x H (mm)
TDK	TFM201610GHM- 1R0MTAA	1.0	50	3.8	3.0	2.0 x 1.6 x 1.0
ТОКО	DFE322512C	1.0	34	4.6	3.7	3.2 x 2.5 x 1.2
Coilcraft	XAL4020-102MEB	1.0	13	8.7	9.6	4.0 x 4.0 x 2.1

Table 2. Suggested Inductors for Buck-Boost

High-Efficiency Buck-Boost Regulator with 5A Switches

- AGND must carefully connect to PGND on the PCB's low-impedance ground plane. Connect AGND to the low-impedance ground plane on the PCB (the same net as PGND) away from any critical loops.
- 5) The IC requires a quiet supply input (SYS) which is often the same net as IN. Carefully bypass SYS to AGND with a dedicated capacitor (C_{SYS}) as close as possible to the IC. Route a dedicated trace between C_{SYS} and the SYS bump. Avoid connecting SYS directly to the nearest IN bumps without dedicated bypassing.
- Connect the OUTS bump to the regulating point with a dedicated trace away from noisy nets such as LX1 and LX2.
- Keep the power traces and load connections short and wide. This is essential for high converter efficiency.
- Do not neglect ceramic capacitor DC voltage derating. Choose capacitor values and case sizes carefully. See the <u>Output Capacitor Selection</u> section and refer to <u>Tutorial 5527</u> for more information.

Serial Interface

The I²C-compatible, 2-wire serial interface is used for regulator on/off control, setting output voltages, and other functions. See the *Register Map* section for details.

The I²C serial bus consists of a bidirectional serial-data line (SDA) and a serial clock (SCL). I²C is an open-drain bus. SDA and SCL require pullup resistors (of 500 Ω or greater). Optional 24 Ω resistors in series with SDA and SCL help to protect the device inputs from high voltage spikes on the bus lines. Series resistors also minimize crosstalk and undershoot on bus lines.

System Configuration

The I²C bus is a multimaster bus. The maximum number of devices that can attach to the bus is only limited by bus capacitance.

Figure 8 shows an example of a typical I²C system. A device on the I²C bus that sends data to the bus is called a transmitter. A device that receives data from the bus is called a receiver. The device that initiates a data transfer and generates SCL clock signals to control the data transfer is a master. Any device that is being addressed by the master is considered a slave. When the MAX77816 I²C compatible interface is operating, it is a slave on I²C bus and it can be both a transmitter and a receiver.

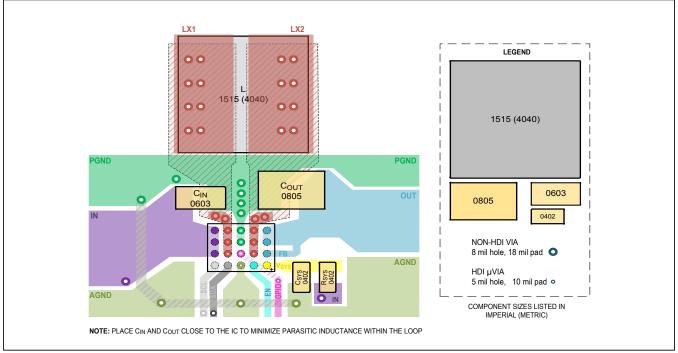


Figure 6. PCB Layout Example (WLP)

High-Efficiency Buck-Boost Regulator with 5A Switches

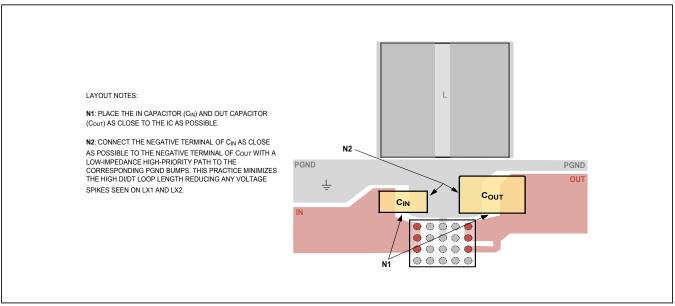


Figure 7. Recommended Capacitor Placement

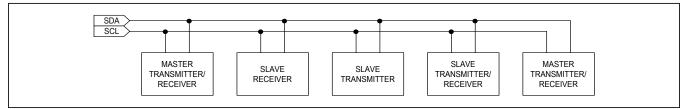


Figure 8. Functional Logic Diagram for Communications Controller

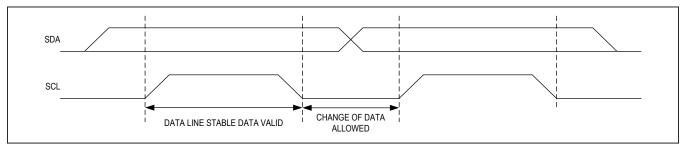


Figure 9. I²C Bit Transfer

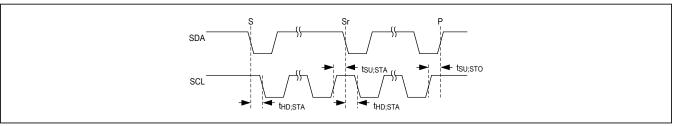


Figure 10. START and STOP Conditions

High-Efficiency Buck-Boost Regulator with 5A Switches

Bit Transfer

One data bit is transferred for each SCL clock cycle. The data on SDA must remain stable during the high portion of SCL clock pulse. Changes in SDA while SCL is high are control signals (START and STOP conditions).

START and STOP Conditions

When the I²C serial interface is inactive, SDA and SCL idle high. A master device initiates communication by issuing a START condition. A START condition is a high-to-low transition on SDA with SCL high. A STOP condition is a low-to-high transition on SDA, while SCL is high.

A START condition from the master signals the beginning of a transmission to the MAX77816. The master terminates transmission by issuing a NOT-ACKNOWLEDGE followed by a STOP condition.

The STOP condition frees the bus. To issue a series of commands to the slave, the master may issue REPEATED START (Sr) commands instead of a STOP command in order to maintain control of the bus. In general, a REPEATED START command is functionally equivalent to a regular START command.

When a STOP condition or incorrect address is detected, the IC internally disconnects SCL from I²C serial interface until the next START condition, minimizing digital noise and feedthrough.

Acknowledged

Both the I²C bus master and MAX77816 (slave) generate acknowledge bits when receiving data. The acknowledge bit is the last bit of each nine-bit data packet. To generate an ACKNOWLEDGE (A), the receiving device must pull SDA low before the rising edge of the acknowledge-

related clock pulse (ninth pulse) and keep it low during the high period of the clock pulse. To generate a NOT-ACKNOWLEDGE (nA), the receiving device allows SDA to be pulled high before the rising edge of the acknowledge-related clock pulse and leaves it high during the high period of the clock pulse.

Monitoring the acknowledge bits allows for detection of unsuccessful data transfers. An unsuccessful data transfer occurs if a receiving device is busy or if a system fault has occurred. In the event of an unsuccessful data transfer, the bus master should reattempt communication at a later time.

Slave Address

The I²C slave address of the IC is shown in Table 3.

Clock Stretching

In general, the clock signal generation for the I²C bus is the responsibility of the master device. The I²C specification allows slow slave devices to alter the clock signal by holding down the clock line. The process in which a slave device holds down the clock line is typically called clock stretching. The IC does not use any form of clock stretching to hold down the clock line.

General Call Address

The IC does not implement the I²C specification called a general call address. If the IC sees a general call address (00000000b), it will not issue an ACKNOWLEDGE (A).

Table 3. I²C Slave Address



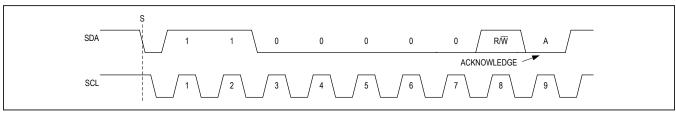


Figure 11. Slave Address Byte Example

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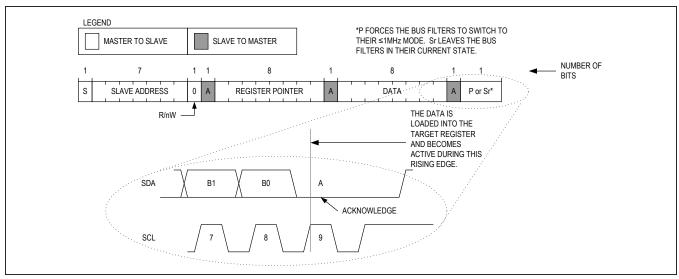


Figure 12. Writing to a Single Register with Write Byte Protocol

Communication Speed

The IC provides I²C 3.0-compatible (3.4MHz) serial interface.

- 0Hz to 100kHz (standard mode)
- 0Hz to 400kHz (fast mode)
- 0Hz to 1MHz (fast mode plus)

Operating in standard mode, fast mode, and fast mode plus does not require any special protocols. The main consideration when changing the bus speed through this range is the combination of the bus capacitance and pullup resistors. Higher time constants created by the bus capacitance and pullup resistance (C x R) slow the bus operation. Therefore, when increasing bus speeds, the pullup resistance must be decreased to maintain a reasonable time constant. Refer to the Pullup Resistor Sizing section of I²C revision 3.0 specification for detailed guidance on the pullup resistor selection. In general, for bus capacitances of 200pF, a 100kHz bus needs 5.6kΩ pullup resistors, a 400kHz bus needs about 1.5kΩ pullup resistors, and a 1MHz bus needs 6800 pullup resistors. Note that the pullup resistor is dissipating power when the open-drain bus is low. The lower the value of the pullup resistor, the higher the power dissipation (V^2/R) .

At power-up and after each STOP condition, the IC input filters are set for standard mode, fast mode, or fast mode plus (i.e., 0Hz to 1MHz).

Communication Protocols

The IC supports both writing and reading from its registers. The following sections show the I²C communication protocols for each functional block. The power block uses the same communications protocols.

Writing to a Single Register

Figure 12 shows the protocol for the I²C master device to write one byte of data to the IC. This protocol is the same as the SMBus specification's write byte protocol.

The write byte protocol is as follows:

- 1) The master sends a START command (S).
- The master sends the 7-bit slave address followed by a write bit (R/nW = 0).
- The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
- 4) The master sends an 8-bit register pointer.
- 5) The slave acknowledges the register pointer.
- 6) The master sends a data byte.
- 7) The slave acknowledges the data byte. At the rising edge of SCL, the data byte will be loaded into its target register and the data will become active.
- 8) The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a STOP condition (P) ensures that the bus input filters are set for 1MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.

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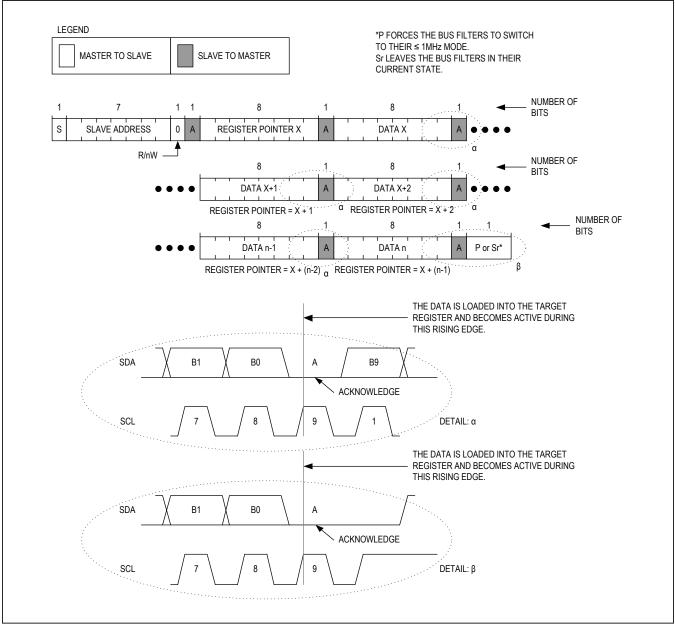


Figure 13. Writing to Sequential Registers X to N

High-Efficiency Buck-Boost Regulator with 5A Switches

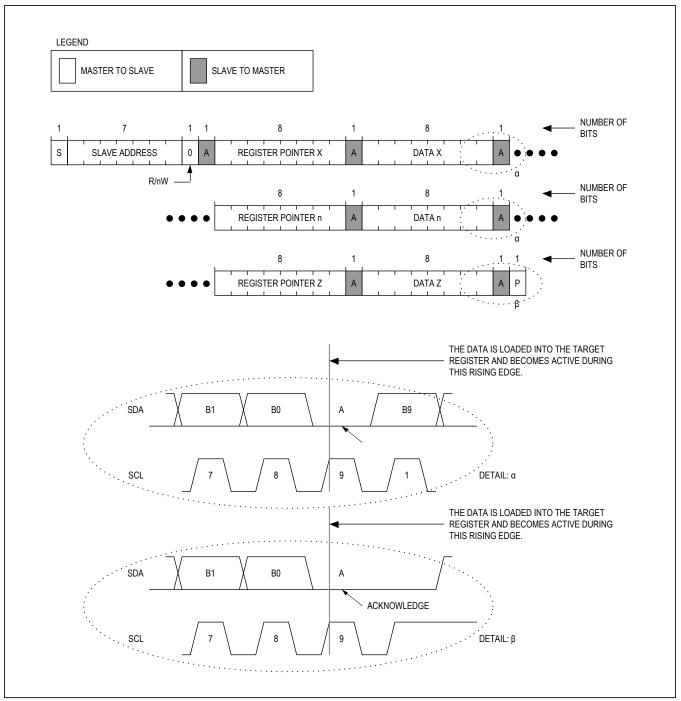


Figure 14. Writing to Multiple Registers with Multiple Byte Register-Data Pairs Protocol

High-Efficiency Buck-Boost Regulator with 5A Switches

Writing to a Sequential Register

Figure 13 shows the protocol for writing to a sequential register. This protocol is similar to the write byte protocol, except the master continues to write after it receives the first byte of data. When the master is done writing, it issues a STOP or REPEATED START.

The writing to sequential registers protocol is as follows:

- 1) The master sends a START command (S).
- The master sends the 7-bit slave address followed by a write bit (R/nW = 0).
- The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
- 4) The master sends an 8-bit register pointer.
- 5) The slave acknowledges the register pointer.
- 6) The master sends a data byte.
- The slave acknowledges the data byte. At the rising edge of SCL, the data byte will be loaded into its target register and the data will become active.
- 8) Steps 6 to 7 are repeated as many times as the master requires.
- 9) During the last acknowledge related clock pulse, the slave issues an ACKNOWLEDGE (A).
- 10) The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a STOP condition (P) ensures that the bus input filters are set for 1MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.

Writing Multiple Bytes using Register-Data Pairs

<u>Figure 14</u> shows the protocol for the I²C master device to write multiple bytes to the IC using register-data pairs. This protocol allows I²C master device to address the slave only once and then send data to multiple registers in a random order. Registers may be written continuously until the master issues a STOP condition.

The multiple byte register-data pair protocol is as follows:

- 1) The master sends a START command.
- 2) The master sends the 7-bit slave address followed by a write bit.
- The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
- 4) The master sends an 8-bit register pointer.
- 5) The slave acknowledges the register pointer.
- 6) The master sends a data byte.
- 7) The slave acknowledges the data byte. At the rising edge of SCL, the data byte will be loaded into its target register and the data will become active.
- 8) Steps 4 to 7 are repeated as many times as the master requires.
- 9) The master sends a STOP condition.

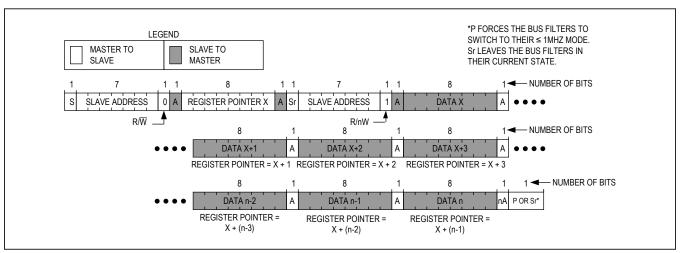


Figure 15. Reading Continuously from Sequential Registers X to N

High-Efficiency Buck-Boost Regulator with 5A Switches

Reading from a Single Register

The I²C master device reads one byte of data to the IC. This protocol is the same as SMBus specification's "Read Byte" protocol.

The "Read Byte" protocol is as follows:

- 1) The master sends a START command (S).
- The master sends the 7-bit slave address followed by a write bit (R/nW = 0).
- The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA LOW.
- 4) The master sends an 8-bit register pointer.
- 5) The slave acknowledges the register pointer.
- 6) The master sends a REPEATED START command (Sr).
- The master sends the 7-bit slave address followed by a read bit (R/nW = 1).
- The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA LOW.
- 9) The addressed slave places 8-bits of data on the bus from the location specified by the register pointer.
- 10) The master issues a NOT-ACKNOWLEDGE (nA).
- 11) The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a STOP condition (P) ensures that the bus input filters are set for 1MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.

Reading from a Sequential Register

Figure 15 shows the protocol for reading from sequential registers. This protocol is similar to the read byte protocol except the master issues an ACKNOWLEDGE (A) to signal the slave that it wants more data. When the master has all the data it requires, it issues a NOT-ACKNOWLEDGE (nA) and a STOP (P) to end the transmission.

The continuous read from sequential registers protocol is as follows:

- 1) The master sends a START command (S).
- The master sends the 7-bit slave address followed by a write bit (R/nW = 0).
- The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
- 4) The master sends an 8-bit register pointer.
- 5) The slave acknowledges the register pointer.
- 6) The master sends a REPEATED START command (Sr).
- The master sends the 7-bit slave address followed by a read bit (R/nW = 1).
- The addressed slave asserts an ACKNOWLEDGE (A) by pulling SDA low.
- 9) The addressed slave places 8-bits of data on the bus from the location specified by the register pointer.
- 10) The master issues an ACKNOWLEDGE (A) signaling the slave that it wishes to receive more data.
- 11) Steps 9 to 10 are repeated as many times as the master requires. Following the last byte of data, the master must issue a NOT-ACKNOWLEDGE (nA) to signal that it wishes to stop receiving data.
- 12) The master sends a STOP condition (P) or a REPEATED START condition (Sr). Issuing a STOP (P) ensures that the bus input filters are set for 1MHz or slower operation. Issuing a REPEATED START (Sr) leaves the bus input filters in their current state.

High-Efficiency Buck-Boost Regulator with 5A Switches

Registers

Register Map

I²C Slave Address (W/R): 0x30 / 0x31

ADDRESS	REGISTER NAME	BIT 7	BIT 6	BIT 5	BIT 4	BIT 3	BIT 2	BIT 1	BIT 0	RESET VALUE
0x00	DEVICE_ID	RSVD		VERS	ION[3:0]		С	HIP_REV[2:0]	—
0x01	STATUS	RSVD	RSVD	RSVD	RSVD	TSHDN	BB_POKn	BB_OVP	BB_ OCP	_
0x02	CONFIG1	ILIM	[1:0]	:0] BB_RU BB_RD BB_OVP_TH[1:0] BB_AD		BB _FPWM	0xCE			
0x03	CONFIG2	RSVD	BB_EN	EN_PD	POK_POL	RSVD	G	PIO_CFG[2:0]	0x71
0x04	VOUT	RSVD				VOUT[6:0]				0x28/ 0x23
0x05	VOUT_H	RSVD		VOUT_H[6:0]					0x78	
0x06	INT_MASK	RSVD	RSVD	RSVD	RSVD	THM_INT _MASK	POK_INT _MASK	OVP_INT _MASK	OCP_INT _MASK	0x00
0x07	INT	RSVD	RSVD	RSVD	RSVD	THM_INT	POK_INT	OVP_INT	OCP_INT	—

Register Reset Conditions

Type-O: Registers are reset when $V_{SYS} < V_{UVLO_F} OR EN = LOW$

DEVICE_ID

Device ID Register

ADDRESS	ACCESS T	ACCESS TYPE		RESET VALUE: N/A
0x00	Read Only		TYPE: O	RESET VALUE. N/A
BIT	NAME	POR		DESCRIPTION
7	RESERVED	—		
6:3	VERSION[3:0]	—	Version 0000b: Default	
2:0	CHIP_REV[2:0]	_	Chip Revision Hi 001b: PASS1	story

High-Efficiency Buck-Boost Regulator with 5A Switches

STATUS

Status Register

ADDRESS	ACCESS T	ACCESS TYPE				
0x01	Read On	ly	TYPE: O	RESET VALUE: N/A		
BIT	NAME	POR	DESCRIPTION			
7:4	RESERVED	_				
3	TSHDN	_	Thermal Shutdown Status 0: Junction temperature $(T_{JCT}) \le 165^{\circ}C$ 1: Junction temperature $(T_{JCT}) > 165^{\circ}C$			
2	BB_POKn	_	Power-OK Status 0: V _{OUTBB} is below the POK threshold 1: V _{OUTBB} is above the POK threshold			
1	BB_OVP	_	Overvoltage Status 0: V _{OUTBB} is below the OVP threshold 1: V _{OUTBB} is above the OVP threshold The OVP threshold is set by BB_OVP_TH[1:0]			
0	BB_OCP		Overcurrent Status 0: Inductor peak current is below the ILIM threshold 1: Inductor peak current is above the ILIM threshold The ILIM threshold is set by ILIM[1:0]			

High-Efficiency Buck-Boost Regulator with 5A Switches

CONFIG1

Configuration Register1

ADDRESS ACCESS TYPE		'PE	TYPE: O	RESET VALUE: 0xCE		
0x02	Read, Writ	te		RESET VALUE: 0XCE		
BIT	NAME	POR		DESCRIPTION		
7:6	ILIM[1:0]	11	Inductor Peak Current Limit 00b: 1.15A 01b: 1.80A 10b: 3.1A 11b: 5A When GPIO_CFG[2:0] = 010b, ILIM[1:0] does not set inductor peak current level. Inductor peak current level is set by GPIO			
5	BB_RU_SR	0	Rising Ramp-Rat 0: 20mV/µs 1: 40mV/µs			
4	BB_RD_SR	0	Ramp-Down Slew Rate Control 0: 5mV/µs 1: 10mV/µs			
3:2	BB_OVP_TH[1:0]	11	Output OVP Threshold 00b: No OVP 01b: 110% of V _{OUT} 10b: 115% of V _{OUT} 11b: 120% of V _{OUT}			
1	BB_AD	1	Output Active Discharge 0: Disable active discharge 1: Enable active discharge			
0	BB_FPWM	0	Forced PWM Enable 0: SKIP mode 1: Forced PWM When GPIO_CFG[2:0] = 001b, BB_FPWM does not set inductor peak current level. Inductor peak current level is set by GPIO			

High-Efficiency Buck-Boost Regulator with 5A Switches

CONFIG2

Configuration Register2

ADDRESS	ACCESS TYPE		TYPE: O	
0x03	Read, Wr	ite	TYPE: O	RESET VALUE: 0x71
BIT	NAME	POR	DESCRIPTION	
7	RESERVED	0		
6	BB_EN	1	0: Disable buck-boost output 1: Enable buck-boost output	
5	EN_PD	1	EN Input Pulldown Resistor Enable Setting 0: Disable 1: Enable	
4	POK_POL	1	0: Active low 1: Active high	
3	RESERVED	0		
2:0	GPIO_CFG[2:0]	001 (A version)	 GPIO Pin Function Configuration 001b: FPWM mode enable, MAX77816A/MAX77816F default 010b: Inductor peak current-limit selection, MAX77816B default 011b: Output voltage selection, MAX77816C default 100b: Power-OK status indication, MAX77816D default 101b: Interrupt indication, MAX77816E default 	

High-Efficiency Buck-Boost Regulator with 5A Switches

VOUT

Output Voltage Setting Register

High-Efficiency Buck-Boost Regulator with 5A Switches

VOUT_H

Output Voltage Setting Register for MAX77816C, GPIO = HIGH

ADDRESS	ACCESS TYPE Read, Write NAME POR					
0x05			TYPE: O		RESET VALUE: 0x78	
BIT			DESCRIPTION			
7	RESERVED	0				
			GPIO_CFG[2:0]≠0 0x00 = 2.60V 0x01 = 2.62V 0x02 = 2.64V 0x03 = 2.66V 0x04 = 2.68V 0x05 = 2.70V 0x06 = 2.72V 0x07 = 2.74V 0x08 = 2.76V 0x09 = 2.78V 0x0A = 2.80V 0x0B = 2.82V 0x0C = 2.84V 0x0D = 2.86V	tt Voltage 11b: VOUT_H sets th 11b: VOUT_H does 0x20 = 3.24V 0x21 = 3.26V 0x22 = 3.28V 0x23 = 3.30V 0x24 = 3.32V 0x25 = 3.34V 0x26 = 3.36V 0x27 = 3.38V 0x28 = 3.40V 0x28 = 3.40V 0x28 = 3.44V 0x2B = 3.46V 0x2C = 3.48V 0x2D = 3.50V	e output voltage whe not control the outp 0x40 = 3.88V 0x41 = 3.90V 0x42 = 3.92V 0x43 = 3.94V 0x43 = 3.94V 0x45 = 3.98V 0x45 = 3.98V 0x46 = 4.00V 0x47 = 4.02V 0x48 = 4.04V 0x48 = 4.04V 0x48 = 4.06V 0x4A = 4.08V 0x4C = 4.12V 0x4D = 4.14V	0x60 = 4.52V 0x61 = 4.54V 0x62 = 4.56V 0x63 = 4.58V 0x64 = 4.60V 0x65 = 4.62V 0x66 = 4.64V 0x68 = 4.68V 0x68 = 4.68V 0x68 = 4.68V 0x68 = 4.72V 0x6A = 4.72V 0x6A = 4.72V 0x6B = 4.74V 0x6C = 4.76V 0x6D = 4.78V
6:0	VOUT_H[6:0]	011 1000	0x0E = 2.88V 0x0F = 2.90V 0x10 = 2.92V 0x11 = 2.94V 0x12 = 2.96V 0x13 = 2.98V 0x14 = 3.00V 0x15 = 3.02V 0x16 = 3.04V 0x16 = 3.04V 0x17 = 3.06V 0x18 = 3.08V 0x18 = 3.10V 0x1A = 3.12V 0x1B = 3.14V 0x1C = 3.16V 0x1D = 3.18V 0x1E = 3.20V	0x2E = 3.52V 0x2F = 3.54V 0x30 = 3.56V 0x31 = 3.58V 0x32 = 3.60V 0x33 = 3.62V 0x34 = 3.64V 0x35 = 3.66V 0x36 = 3.68V 0x37 = 3.70V 0x38 = 3.72V 0x38 = 3.72V 0x3B = 3.76V 0x3B = 3.78V 0x3C = 3.80V 0x3D = 3.82V 0x3E = 3.84V	0x4E = 4.16V 0x4F = 4.18V 0x50 = 4.20V 0x51 = 4.22V 0x52 = 4.24V 0x53 = 4.26V 0x54 = 4.28V 0x55 = 4.30V 0x56 = 4.32V 0x57 = 4.34V 0x58 = 4.36V 0x58 = 4.36V 0x58 = 4.40V 0x5B = 4.42V 0x5D = 4.46V 0x5E = 4.48V	0x6E = 4.80V 0x6F = 4.82V 0x70 = 4.84V 0x71 = 4.86V 0x72 = 4.88V 0x73 = 4.90V 0x74 = 4.92V 0x75 = 4.94V 0x76 = 4.96V 0x77 = 4.98V 0x78 = 5.00V 0x78 = 5.02V 0x7B = 5.06V 0x7C = 5.08V 0x7D = 5.10V 0x7E = 5.12V

High-Efficiency Buck-Boost Regulator with 5A Switches

INT_MASK

Interrupt Mask Register

ADDRESS	ACCESS TYPE		TYPE: O	RESET VALUE: 0x00
0x06	Read, Wri	te	TIPE: 0	RESET VALUE. 0X00
BIT	NAME	POR		DESCRIPTION
7:4	RESERVED	0000		
3	THM_INT_MASK	0	Thermal Shutdown Interrupt Mask Bit 0: Unmask 1: Mask	
2	POK_INT_MASK	0	Power-OK Interrupt Mask Bit 0: Unmask 1: Mask	
1	OVP_INT_MASK	0	OVP Interrupt Mask Bit 0: Unmask 1: Mask	
0	OCP_INT_MASK	0	OCP interrupt mask bit 0: Unmask 1: Mask	

INT

Interrupt Status Register

ADDRESS	ACCESS TYPE		TYPE: O	RESET VALUE: N/A
0x07	Read and C	Read and Clear		RESET VALUE. N/A
BIT	NAME	POR	DESCRIPTION	
7:4	RESERVED	0000		
3	THM_INT	0	Thermal Shutdown Interrupt Bit 0: No status change or status change from 1 to 0 for TSHDN 1: Status change from 0 to 1 happened for TSHDN	
2	POK_INT	0	Power-OK Interrupt Bit 0: No status change or status change from 1 to 0 for BB_POKn 1: Status change from 1 to 0 happened for BB_POKn	
1	OVP_INT	0	OVP Interrupt Bit 0: No status change or status change from 1 to 0 for BB_OVP 1: Status change from 0 to 1 happened for BB_OVP	
0	OCP_INT	0	OCP Interrupt Bit 0: No status change or status change from 1 to 0 for BB_OCP 1: Status change from 0 to 1 happened for BB_OCP	

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Ordering Information

PART	DEFAULT VOUT	GPIO DEFAULT TYPE	GPIO DEFAULT FUNCTION
MAX77816AEWP+T	3.4V	Input	FPWM Mode Enable
MAX77816BEWP+T	3.3V	Input	Inductor Peak Current Limit Selection
MAX77816CEWP+T	3.3V/5V	Input	Output Voltage Selection
MAX77816DEWP+T	3.3V	Output	Power-OK Status Indication
MAX77816EEWP+T*	3.3V	Output	Interrupt Indication
MAX77816FEWP+T*	3.3V	Input	FPWM Mode Enable

+Denotes a lead(Pb)-free/RoHS-compliant package.

T = Tape and reel.

*Future product—Contact Maxim for availability.

Package Information

For the latest package outline information and land patterns (footprints), go to <u>www.maximintegrated.com/packages</u>. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
20 WLP	W201F2+1	<u>21-0771</u>	Refer to Application Note 1891

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Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	6/17	Initial release	—
1	3/18	Released MAX77816B and MAX77816C, added MAX77816F information	1, 2, 7, 8, 18, 21–23, 25, 26
2	6/19	Updated package measurements, added <i>PCB Layout Guidelines</i> section, updated <i>Ordering Information</i> table	7, 11, 27
3	10/19	Updated LXBB in the <i>Absolute Maximum Ratings</i> section, updated Shutdown Supply Current and LXBB1/2 Current Limit in the <i>Electrical Characteristics</i> table	2, 3
4	7/20	Updated Typical Operating Characteristics section	6–8

For pricing, delivery, and ordering information, please visit Maxim Integrated's online storefront at https://www.maximintegrated.com/en/storefront/storefront.html.

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